

DUAL 2 TO 4 DECODER/DEMULTIPLEXER

- HIGH SPEED: $t_{PD} = 5.0$ ns (TYP.) at $V_{CC} = 5V$
- LOW POWER DISSIPATION:
 $I_{CC} = 4 \mu A$ (MAX.) at $T_A=25^\circ C$
- HIGH NOISE IMMUNITY:
 $V_{NIH} = V_{NIL} = 28\%$ V_{CC} (MIN.)
- POWER DOWN PROTECTION ON INPUTS
- SYMMETRICAL OUTPUT IMPEDANCE:
 $|I_{OHI}| = I_{OL} = 8$ mA (MIN)
- BALANCED PROPAGATION DELAYS:
 $t_{PLH} \approx t_{PHL}$
- OPERATING VOLTAGE RANGE:
 $V_{CC}(OPR) = 2V$ to $5.5V$
- PIN AND FUNCTION COMPATIBLE WITH
 74 SERIES 139
- IMPROVED LATCH-UP IMMUNITY

DESCRIPTION

The 74VHC139 is an advanced high-speed CMOS DUAL 2 TO 4 LINE DECODER/DEMULITPLEXER fabricated with sub-micron silicon gate and double-layer metal wiring C²MOS technology.

The active low enable input can be used for gating or as a data input for demultiplexing applications. While the enable input is held high, all four outputs are high independently of the other inputs.

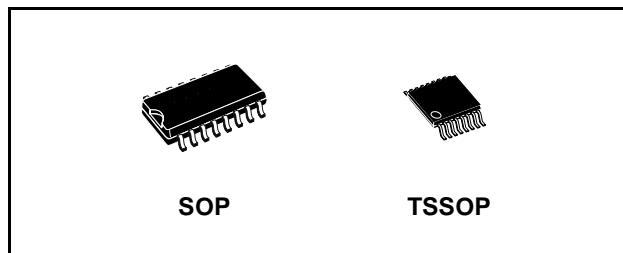


Table 1: Order Codes

PACKAGE	T & R
SOP	74VHC139MTR
TSSOP	74VHC139TTR

Power down protection is provided on all inputs and 0 to 7V can be accepted on inputs with no regard to the supply voltage. This device can be used to interface 5V to 3V.

All inputs and outputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

Figure 1: Pin Connection And IEC Logic Symbols

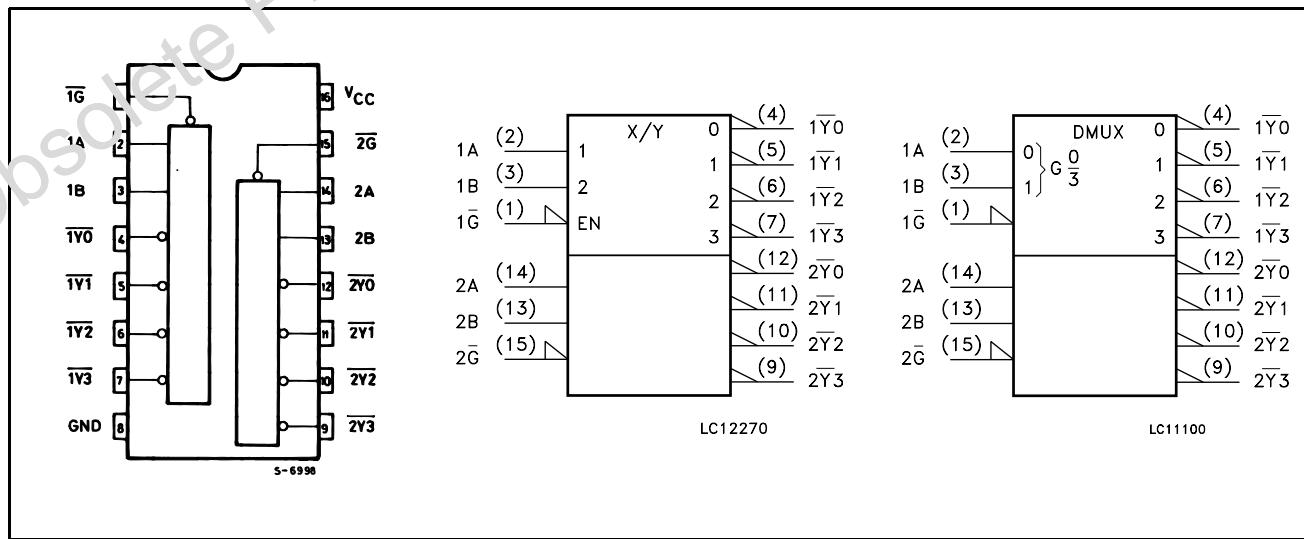
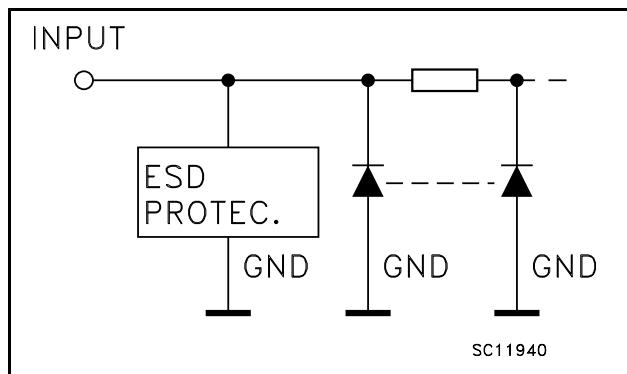


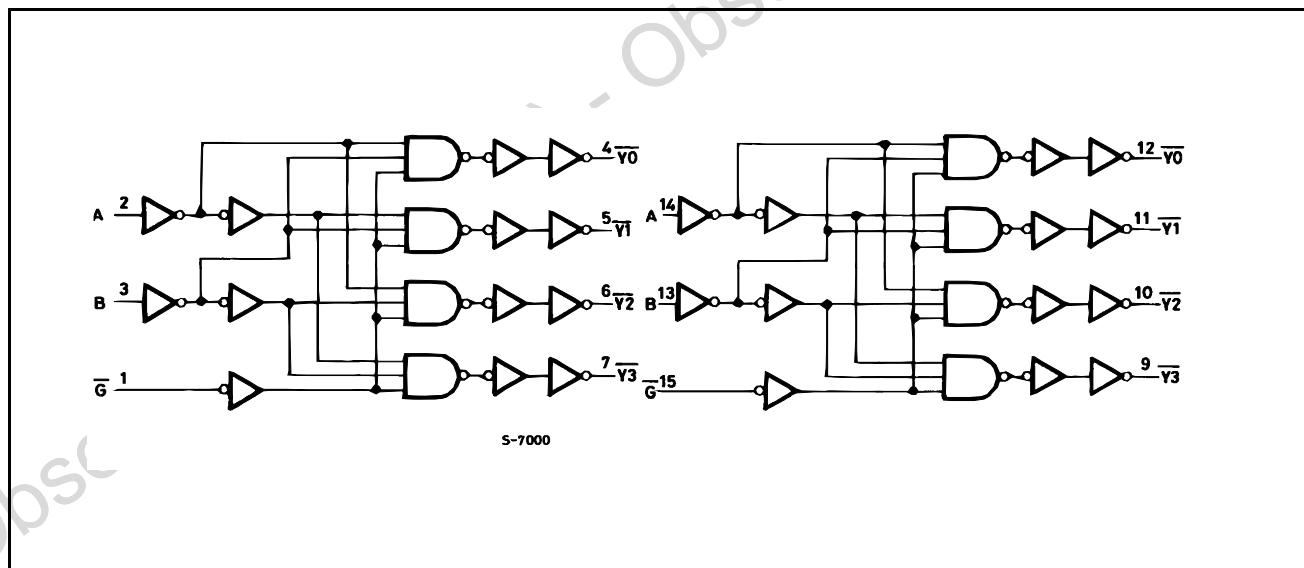
Figure 2: Input Equivalent Circuit**Table 2: Pin Description**

PIN N°	SYMBOL	NAME AND FUNCTION
1, 15	1G, 2G	Enable Inputs
2, 3	1A, 1B	Address Inputs
4, 5, 6, 7	1Y0 to 1Y3	Outputs
12, 11, 10, 9	2Y0 to 2Y3	Outputs
14, 13	2A, 2B	Address Inputs
8	GND	Ground (0V)
16	V _{CC}	Positive Supply Voltage

Table 3: Truth Table

INPUTS			OUTPUTS			
ENABLE	SELECT		\bar{Y}_0	\bar{Y}_1	\bar{Y}_2	\bar{Y}_3
\bar{G}	B	A	H	H	H	H
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	L	H	H	L	H	H
L	H	L	H	H	L	H
L	H	H	H	H	H	L

X : Don't care

Figure 3: Logic Diagram

This logic diagram has not be used to estimate propagation delays

Table 4: Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	-0.5 to +7.0	V
V_I	DC Input Voltage	-0.5 to +7.0	V
V_O	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
I_{IK}	DC Input Diode Current	- 20	mA
I_{OK}	DC Output Diode Current	± 20	mA
I_O	DC Output Current	± 25	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current	± 75	mA
T_{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied

Table 5: Recommended Operating Conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	2 to 5.5	V
V_I	Input Voltage	0 to 5.5	V
V_O	Output Voltage	0 to V_{CC}	V
T_{op}	Operating Temperature	-55 to 125	°C
dt/dv	Input Rise and Fall Time (note 1) ($V_{CC} = 3.3 \pm 0.3V$) ($V_{CC} = 5.0 \pm 0.5V$)	0 to 100 0 to 20	ns/V

1) V_{IN} from 30% to 70% of V_{CC}

Table 6: DC Specifications

Symbol	Parameter	Test Condition		Value						Unit	
		V _{CC} (V)		T _A = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V _{IH}	High Level Input Voltage	2.0		1.5			1.5		1.5		V
		3.0 to 5.5		0.7V _{CC}			0.7V _{CC}		0.7V _{CC}		
V _{IL}	Low Level Input Voltage	2.0				0.5		0.5		0.5	V
		3.0 to 5.5				0.3V _{CC}		0.3V _{CC}		0.3V _{CC}	
V _{OH}	High Level Output Voltage	2.0	I _O =-50 μA	1.9	2.0		1.9		1.9		V
		3.0	I _O =-50 μA	2.9	3.0		2.9		2.9		
		4.5	I _O =-50 μA	4.4	4.5		4.4		4.4		
		3.0	I _O =-4 mA	2.58			2.48		2.4		
		4.5	I _O =-8 mA	3.94			3.8		3.7		
V _{OL}	Low Level Output Voltage	2.0	I _O =50 μA		0.0	0.1		0.1		0.1	V
		3.0	I _O =50 μA		0.0	0.1		0.1		0.1	
		4.5	I _O =50 μA		0.0	0.1		0.1		0.1	
		3.0	I _O =4 mA		0.36		0.44		0.55		
		4.5	I _O =8 mA		0.36		0.44		0.55		
I _I	Input Leakage Current	0 to 5.5	V _I = 5.5V or GND			± 0.1		± 1		± 1	μA
I _{CC}	Quiescent Supply Current	5.5	V _I = V _{CC} or GND			4		40		40	μA

Table 7: AC Electrical Characteristics (Input t_r = t_f = 3ns)

Symbol	Parameter	Test Condition			Value						Unit	
		V _{CC} (V)	C _L (pF)		T _A = 25°C			-40 to 85°C		-55 to 125°C		
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
t _{PLH} t _{PHL}	Propagation Delay Time A, B to \bar{Y}	3.3 ^(*)	15			7.2	11.0	1.0	13.0	1.0	13.0	ns
		3.3 ^(*)	50			9.7	14.5	1.0	16.5	1.0	16.5	
		5.0 ^(**)	15			5.0	7.2	1.0	8.5	1.0	8.5	
		5.0 ^(**)	50			6.5	9.2	1.0	10.5	1.0	10.5	
t _{PLH} t _{PHL}	Propagation Delay Time G to \bar{Y}	3.3 ^(*)	15			6.4	9.2	1.0	11.0	1.0	11.0	ns
		3.3 ^(*)	50			8.9	12.7	1.0	14.5	1.0	14.5	
		5.0 ^(**)	15			4.4	6.3	1.0	7.5	1.0	7.5	
		5.0 ^(**)	50			5.9	8.3	1.0	9.5	1.0	9.5	

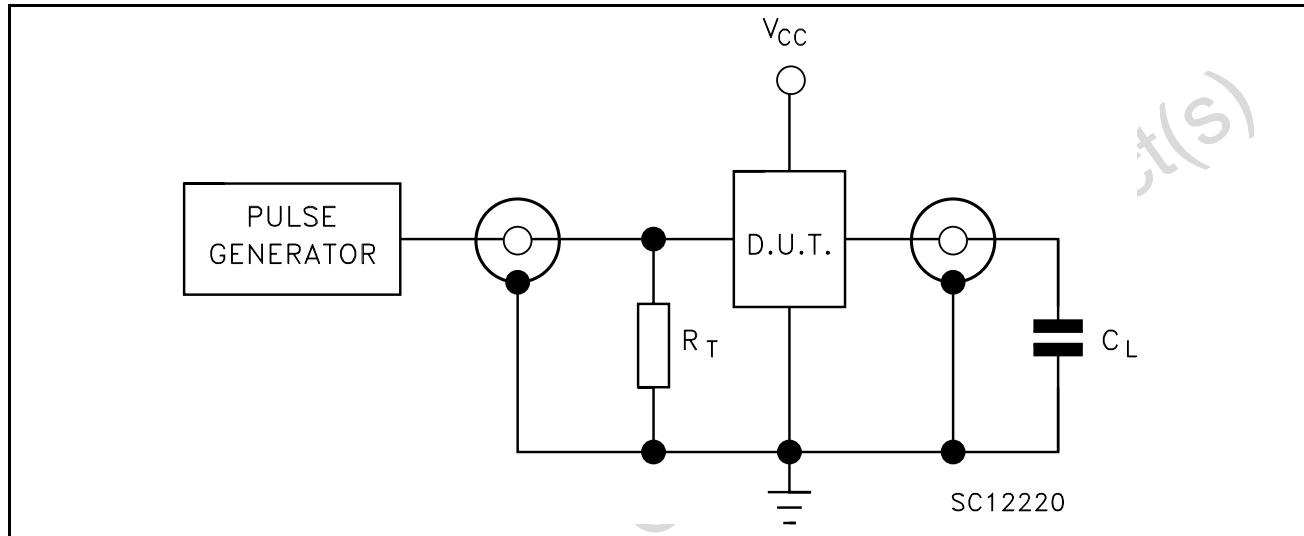
(*) Voltage range is 3.3V ± 0.3V

(**) Voltage range is 5.0V ± 0.5V

Table 8: Capacitive Characteristics

Symbol	Parameter	Test Condition		Value						Unit
		TA = 25°C			-40 to 85°C		-55 to 125°C			
		Min.	Typ.	Max.	Min.	Max.	Min.	Max.		
C _{IN}	Input Capacitance				4	10		10		pF
C _{PD}	Power Dissipation Capacitance (note 1)				26					pF

1) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. I_{CC(opr)} = C_{PD} × V_{CC} × f_{IN} + I_{CC}/2 (per Decoder)

Figure 4: Test Circuit

C_L = 15/50 pF or equivalent (includes jig and probe capacitance)
R_T = Z_{OUT} of pulse generator (typically 50Ω)

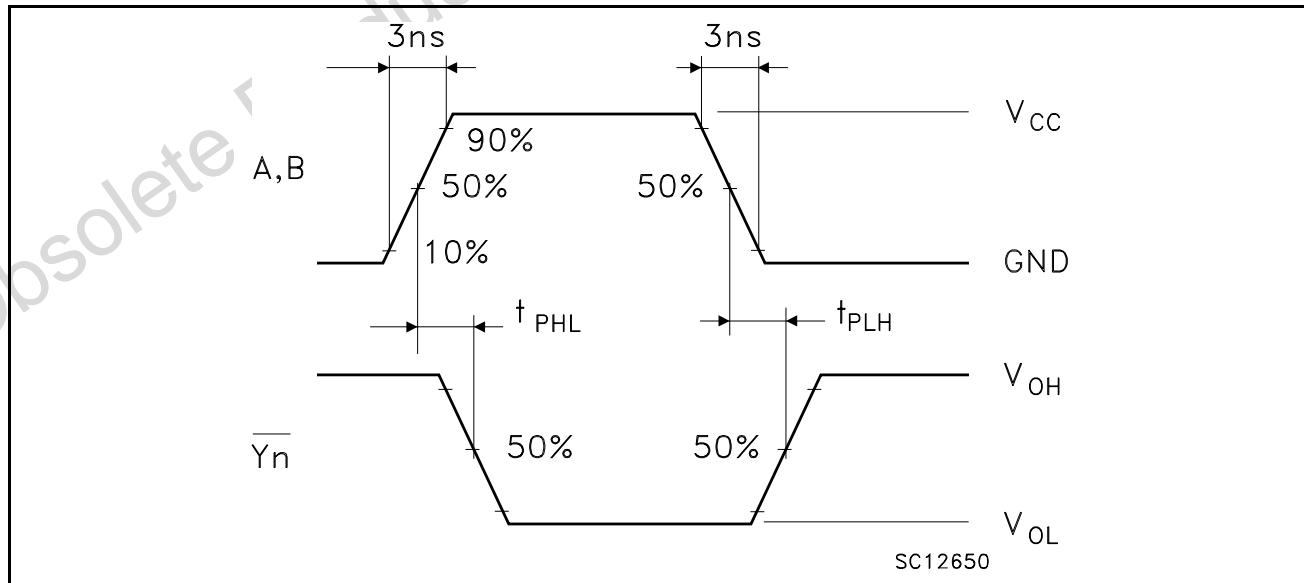
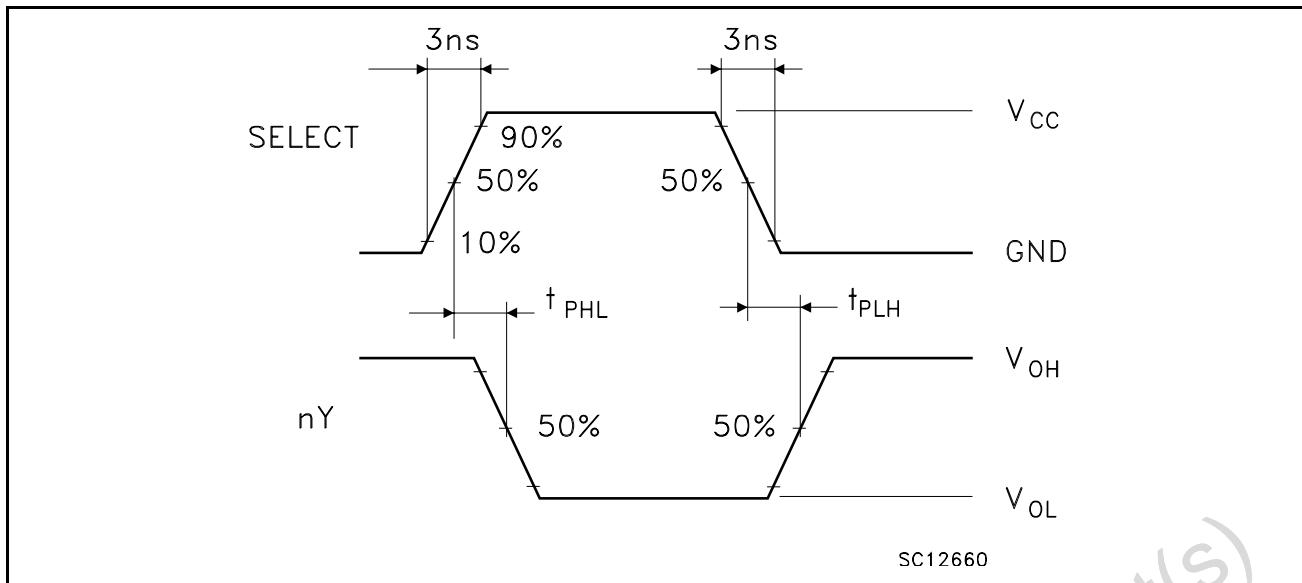
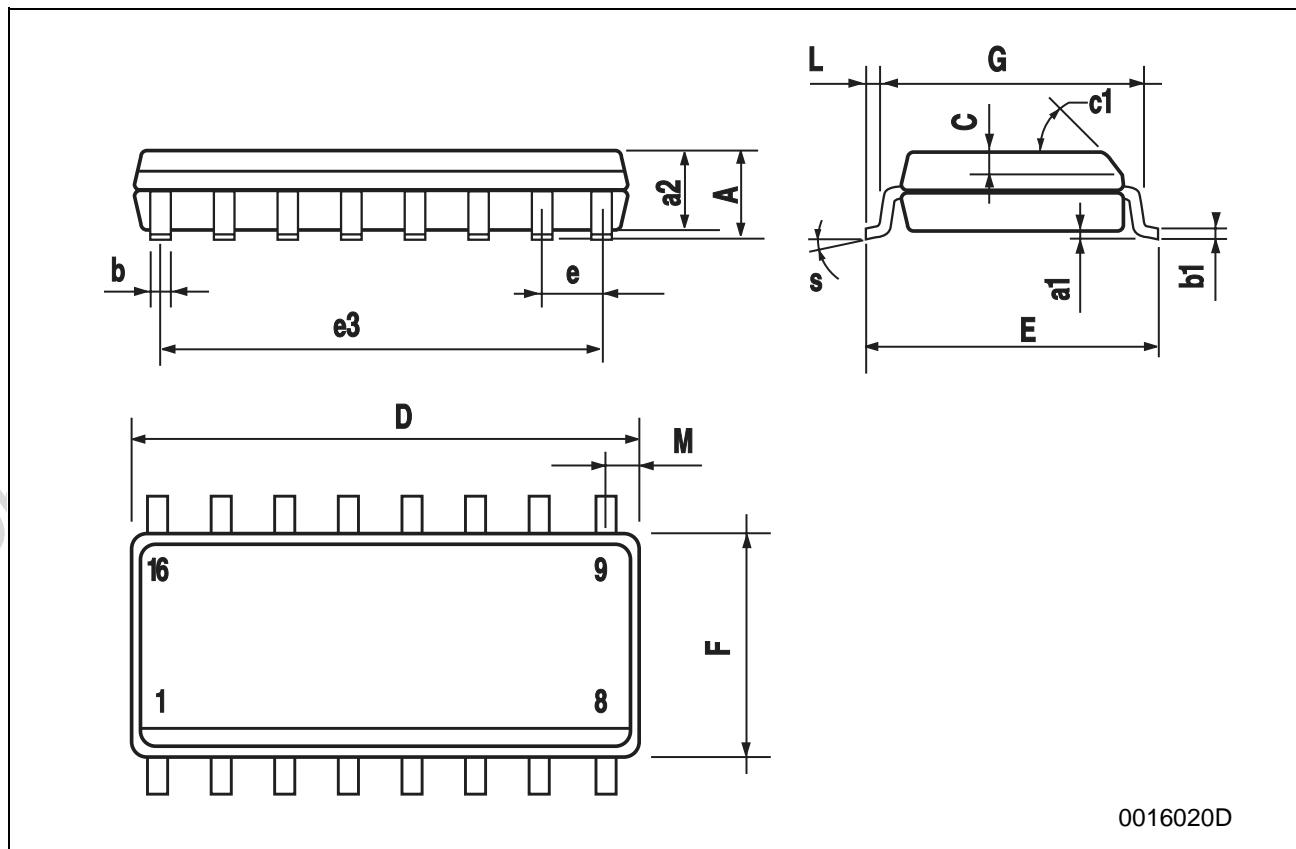
Figure 5: Waveform - Propagation Delays For Inverting Outputs (f=1MHz; 50% duty cycle)

Figure 6: Waveform - Propagation Delays For Non-inverting Outputs (f=1MHz; 50% duty cycle)

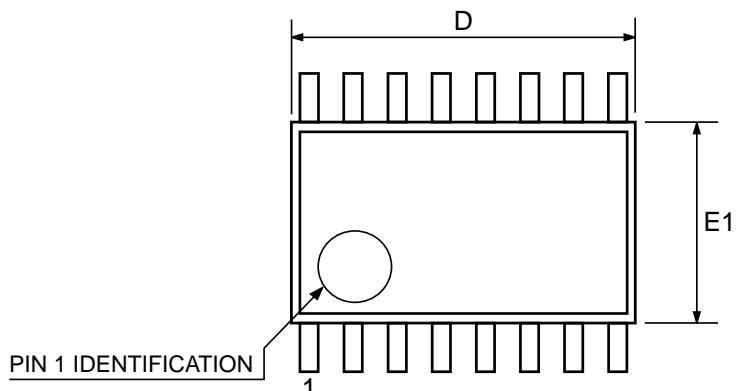
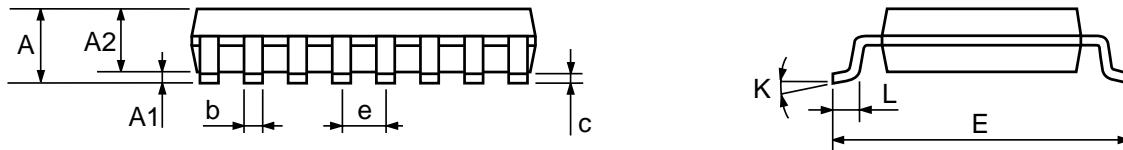
SO-16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.25	0.004		0.010
a2			1.64			0.063
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1		45° (typ.)				
D	9.8		10	0.385		0.393
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.62			0.024
S		8° (max.)				



TSSOP16 MECHANICAL DATA

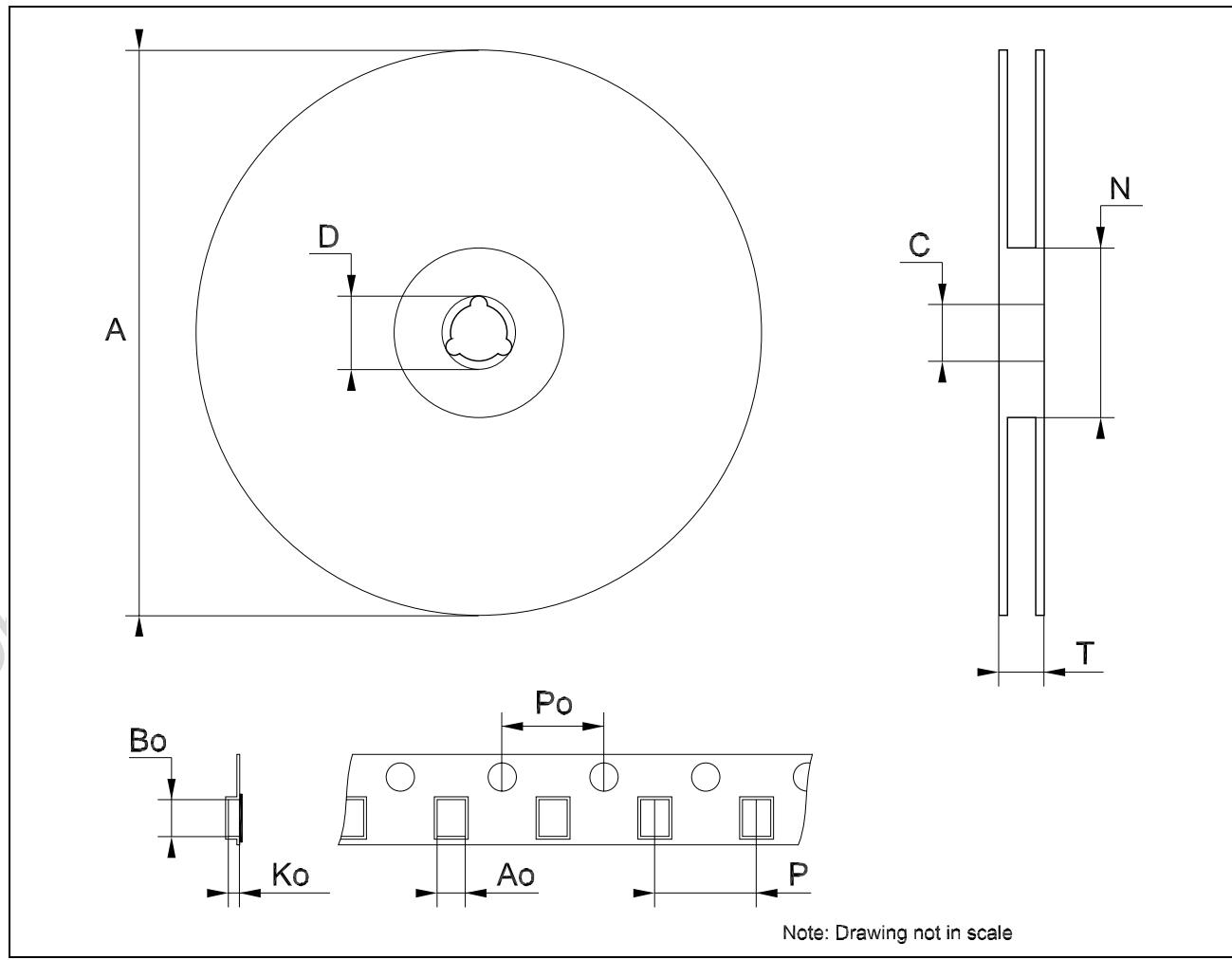
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



0080338D

Tape & Reel SO-16 MECHANICAL DATA						
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DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.45		6.65	0.254		0.262
Bo	10.3		10.5	0.406		0.414
Ko	2.1		2.3	0.082		0.090
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



Tape & Reel TSSOP16 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.7		6.9	0.264		0.272
Bo	5.3		5.5	0.209		0.217
Ko	1.6		1.8	0.063		0.071
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319

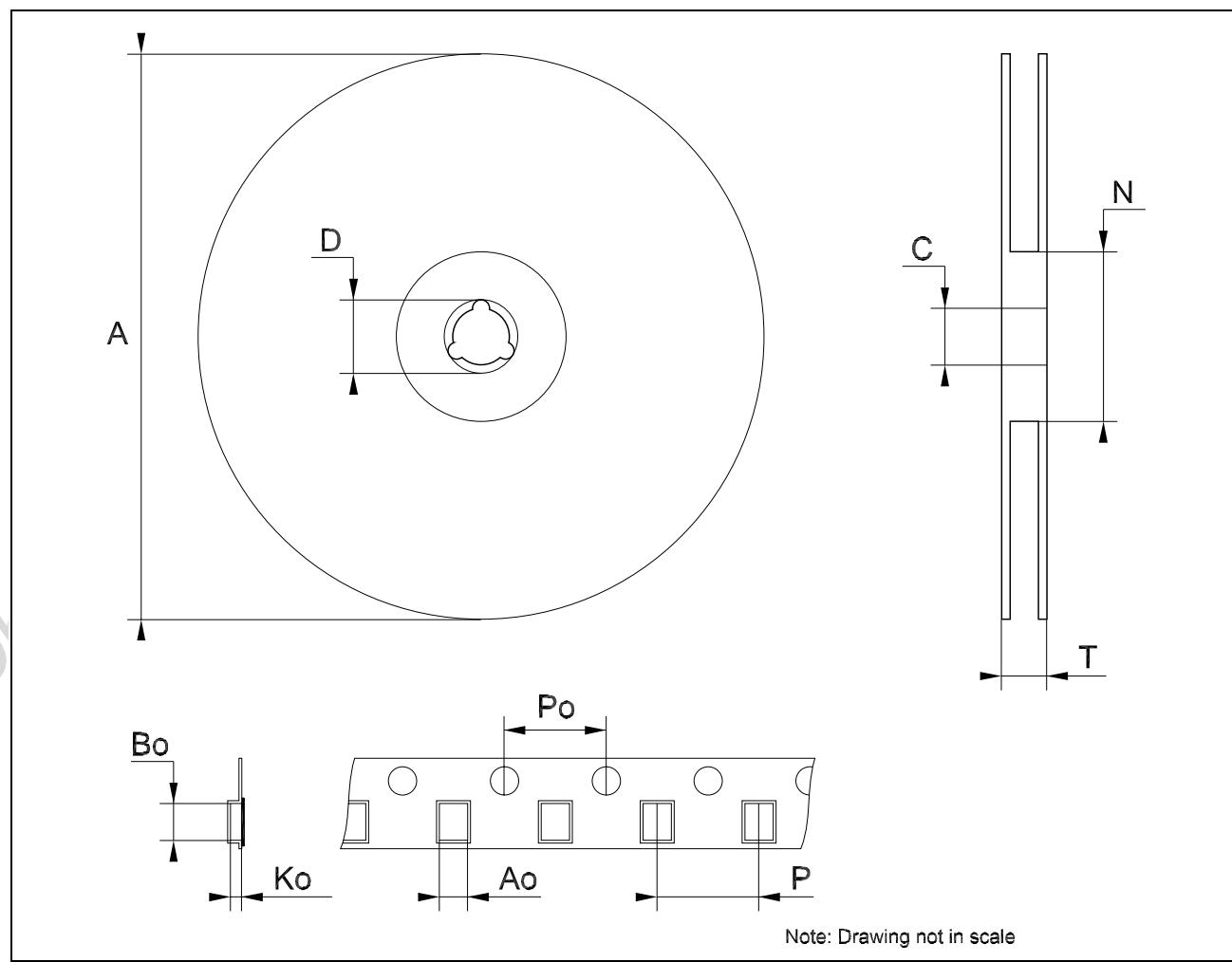


Table 9: Revision History

Date	Revision	Description of Changes
12-Nov-2004	4	Order Codes Revision - pag. 1.

Obsolete Product(s) - Obsolete Product(s)



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